

LANC4812W12

DC/DC Converter 36-75 VDC Input 12 VDC Output at 1.0A





Applications:

- Distributed Power Architectures
- Communications Equipment
- Computer Equipment
- Work Stations

Features:

- RoHS Compliant
- Single Output
- Standard 24 Pin DIP and SMT Package
- Five-Sided Continuous Shield
- No Minimum Load Required
- High Power Density
- High Efficiency up to 88%
- Small Size: 1.25 x 0.8 x 0.450 Inches
- Input to Output Isolation (1600VDC)
- 2:1 Wide Input Voltage Range
- Fixed Switching Frequency
- Input Under-Voltage Protection
- Output Over-Voltage Protection
- Over-Current Protection
- Output Short Circuit Protection
- Remote ON/OFF

Description:

The LANCW12 single output series offers 12 watts of output power from a package in an IC compatible 24pin DIP and SMT configuration. LANCW12 single output series has 2:1 wide input voltage of 9-18VDC, 18-36VDC, and 36-75VDC. The LANCW12 single output series features 1600VDC of isolation, short circuit protection and five sided shielding. All models are particularly suited for telecommunications, industrial, mobile telecom, and test equipment applications.



TECHNICAL DATASHEET

LANC4812W12

Technical Specifications	Model No. LANC				
All specifications are based on 2	5 °C, Nominal Input Voltage and Maximum Outpu	t Current unless	otherwise n	oted.	
	ne right to change specifications based on technolog		3.7	3.5	TT
SPECIFICATION	Related condition	Min	Nom	Max	Unit
Switching Frequency	Test at nominal Vin and full load		400		kHz
INPUT (V _{in})					
Operating Voltage Range		36	48	75	Vdc
Input Voltage (Continuous)				80	Vdc
Input Voltage (Transient 100ms)				100	Vdc
UVLO Turn-on Threshold			36		Vdc
UVLO Turn-off Threshold			33		Vdc
Input Standby Current	Nominal Vin and No Load		11		mA
Input Voltage Variation	Complies with EST300 132 part 4.4		11	5	V/ms
Input Current	Nominal Vin and Full Load			301	mA
Reflected Ripple Current	5 to 20MHz, 12μH source impedance		20		mA_{pk}
Tronousa Trippio Current	(See the Test Setup section - pg 8)		_0		1111 -рк
EFFICIENCY	Test at nominal Vin and full load		87		%
EFFICIENCY	(See the Test Setup section – pg 8)		07		/0
OUTPUT (V _o)					
Operating Output Range	Nominal Vin and Full Load	11.85	6 12	12.144	Vdc
Load Regulation (DIP Type)	0% to 100% Full Load	-0.5		+0.5	%
Load Regulation (SMT Type)	0% to 100% Full Load	-1.0		+1.0	%
		-0.2			%
Line Regulation	LL to HL at Full Load	-0.2		+0.2	70
Output Ripple & Noise	5Hz to 20MHz bandwidth			85	mV_{pk}
	(See the Test Setup section - pg 8)				_
Output Current		0		1.0	Α
Output Voltage Overshoot	LL to HL at Full Load		0	3	% Vo
Over Voltage Protection	Zener diode clamp		15		Vdc
Over Current Protection	•		150		% FL
Short Circuit Protection		Co	ntinuous, au	itomatic re	
DYNAMIC LOAD RESPONSE	Test at nominal Vin		iiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiii		
Peak Deviation	Load step change from 75 to 100% or 100 to 75 s	% of FI	200		mV
	Load step change from 73 to 100% of 100 to 73	70 OI I L	250		
Setting Time (Vout < 10% peak deviation)	TI ONIOFE: 10 : C 10 W		230		μs
REMOTE ON/OFF	The ON/OFF pin voltage is referenced to -Vin				
ONIORE : III I II II (D ONI)	(See the Remote ON/OFF Control section - pg 5)			10	3.7.1
ON/OFF pin High Voltage (Remote ON)		3.0		12	Vdc
ON/OFF pin Low Voltage (Remote OFF)		0		1.2	Vdc
ON/OFF pin Low Voltage, input current				2.5	mA
START UP TIME	Test at nominal Vin and constant resistive load				
Power Up			450		ms
Remote ON/OFF			5		ms
ISOLATION					
Isolation Voltage (Input-Output)		1600			Vdc
Isolation Voltage (Input-Output) Isolation Voltage (Output to Case–DIP Type)		1600			Vdc
Isolation Voltage (Output to Case–DIP Type)		1000			Vdc
Isolation Voltage (Input to Case - DIP Type)		1600			Vdc
Isolation Voltage (Input to Case - SMT Type)		1000			Vdc
Isolation Resistance		1			$G\Omega$
Isolation Capacitance				1200	pF
ENVIRONMENTAL					
Operating Ambient Temperature (w/ derating)		-40		85	°C
Operating Case Temperature		. •		100	°C
Storage Temperature		-55		105	°C
Temperature Coefficient		-0.02		+0.02	%/°(
	Contho MTDE and Dalidatic continuous (m. 12)	-0.02		±0.02	70 / 1
MTBF	See the MTBF and Reliability section (pg 13)				
Bellcore TR-NWT-000332, T _C =40°C			2,750,000		hours
MIL-STD-217F			1,080,000)	hours
MECHANICAL			See I	igure 1	
Weight			18.0		gram
Dimensions		1	25 x 0.8 x (150	inche



Figure 1: Mechanical Dimensions

DIP Type

Pin size is 0.02(0.5) Dia or 0.01 x 0.02 (0.25 x 0.50) Rectangular Pin

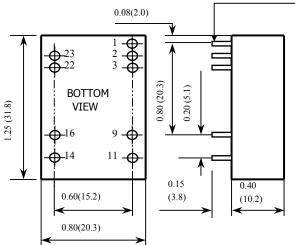


Table 1 **Pin Connection** Pin Define Pin **Define CTRL** 1 2 -Input 23 +Input 3 -Input 22 +Input 9 NC 16 -Output

14

+Output

NC

1. All dimensions are in Inches (mm)

Tolerance: x.xx±0.02 (x.x±0.5)

2. Pin pitch tolerance ±0.014(0.35)

Suffix-S



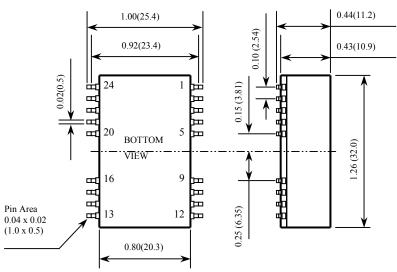


Table 2

11

Pin Connection					
Pin	Define Pin Define				
1	CTRL				
2	-Input	23	+Input		
3	-Input	22	+Input		
9	NC	16	-Output		
11	NC	14	+Output		
Others	NC	Others	NC		

1. All dimensions in Inches (mm)

Tolerance: x.xx±0.02 (x.x±0.5)

2. Pin pitch tolerance ±0.014(0.35)



DESIGN CONSIDERATIONS:

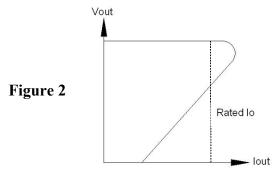
Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150% of rated current for the LANCW12 single output series.

Fold back-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to operate normally when the fault is removed.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of fold back is as follows. When the current sense circuit sees an over-current event, the output voltage of the module will be decreased for low power dissipation and decrease the heat of the module.



Output Over Voltage Protection

The output over-voltage protection consists of an output Zener diode that monitors the voltage on the output terminals. If the voltage on the output terminals exceeds the over-voltage protection threshold, then the Zener diode clamps the output voltage.

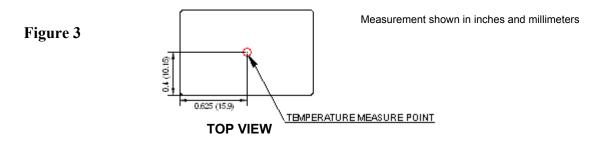
Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Input external L-C filter is recommended to minimize input reflected ripple current. The inductor is simulated source impedance of $12\mu H$ and capacitor is Nippon chemi-con KZE series $47\mu F/100V$. The capacitor must as close as possible to the input terminals of the power module for lower impedance.



Thermal Consideration

The power module operates in a variety of thermal environments. However, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convention, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although the maximum point temperature of the power modules is 105°C, you can limit this temperature to a lower value for extremely high reliability.

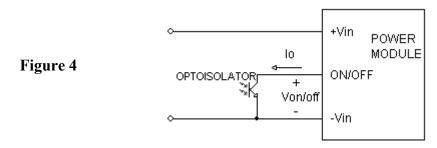


Remote ON/OFF Control

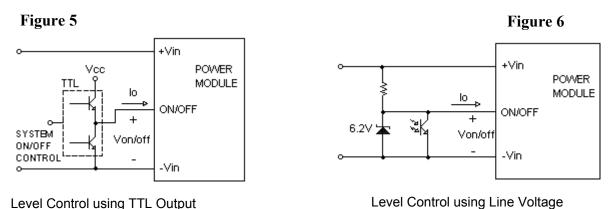
The positive logic remote ON/OFF control circuit is included.

Turns the module ON during a logic High on the On/Off pin and turns OFF during a logic Low. The On/Off pin is an open collector/drain logic input signal (Von/off) that's referenced to GND. If not using the Remote On/Off feature, please open circuit between on/off pin and –input pin to turn the module on.

Remote ON/OFF Implementation



Isolated-Closure Remote ON/OFF



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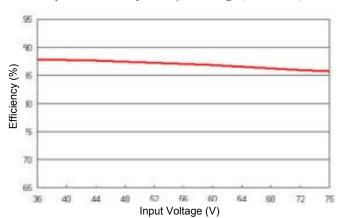


Graph 1: Efficiency vs. Output Current

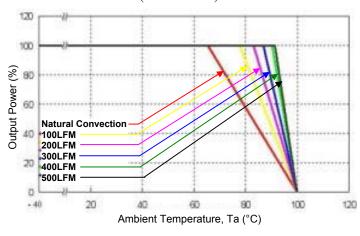
Win=36V
Vin=48V
Vin=75V

% Of Full Load

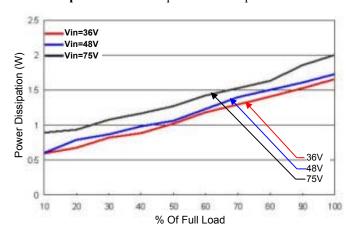
Graph 2: Efficiency vs. Input Voltage (Full Load)



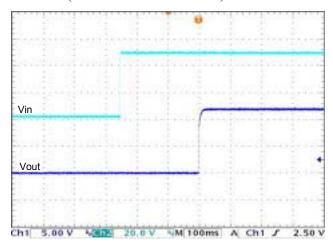
Graph 3: Output Power vs. Ambient Temperature & Airflow (Nominal Vin)



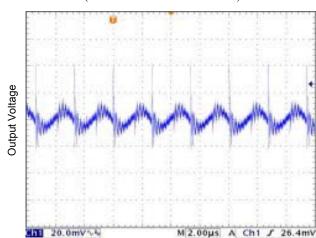
Graph 4: Power Dissipation Vs. Output Current



Graph 5: Typical Input Start-Up and Output Rise Characteristic (Nominal Vin and Full Load)

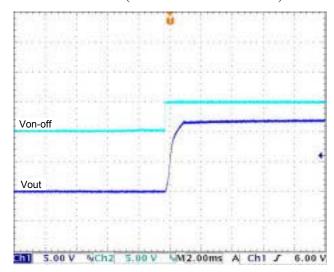


Graph 6: Typical Output Ripple and Noise (Nominal Vin and Full Load)

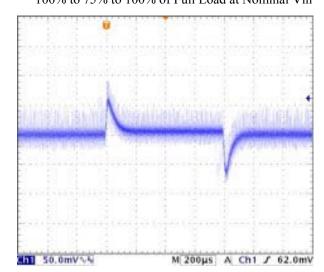




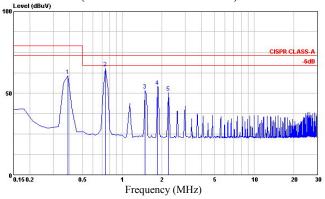
Graph 7: Using ON/OFF Voltage Start-Up and Vo Rise Characteristic (Nominal Vin and Full Load)



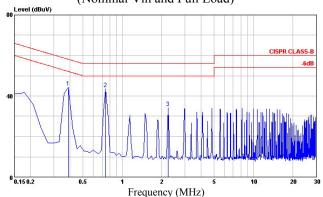
Graph 8: Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load at Nominal Vin



Graph 9: Conducted Emission of EN55022 Class A (Nominal Vin and Full Load)



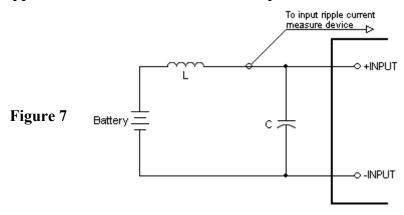
Graph 10: Conducted Emission of EN55022 Class B (Nominal Vin and Full Load)



TEST SETUP:

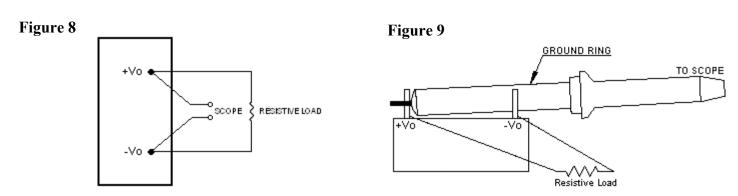
The LANC4812W12 specifications are tested with the following configurations:

Input Reflected-Ripple Current Measurement Test Setup



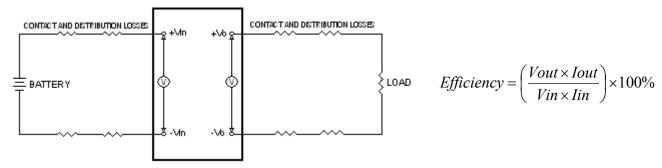
Component	Value	Voltage	Reference
L	12µH		
С	47µF	100V	Aluminum Electrolytic Capacitor

Peak-to-Peak Output Ripple & Noise Measurement Setup



Output Voltage and Efficiency Measurement Setup

Figure 10



NOTE: All measurements are taken at the module terminals

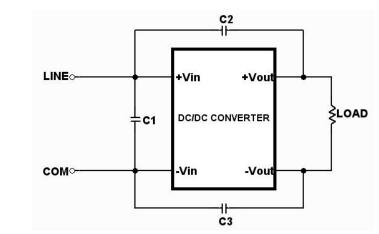


Figure 11

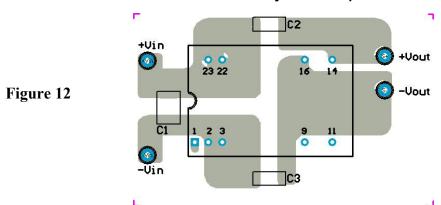
TECHNICAL DATASHEET LANC4812W12

EMC Considerations

Suggested Schematic for EN55022 Conducted Emission Class A Limits



Recommended Layout with Input Filter



To meet Conducted Emissions EN55022 CLASS A needed the following components:

LANC12xxW12

Component	Value	Voltage	Reference
C1	6.8uF	50V	1210 MLCC
C2, C3	1000pF	2KV	1206 MLCC

LANC24xxW12

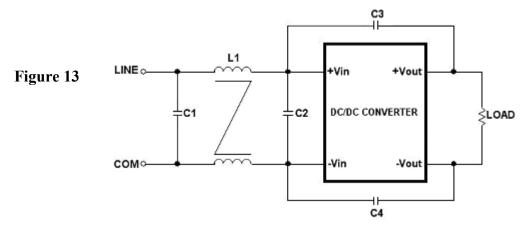
Component	Value	Voltage	Reference
C1	4.7uF	50V	1210 MLCC
C2, C3	1000pF	2KV	1206 MLCC

LANC48xxW12

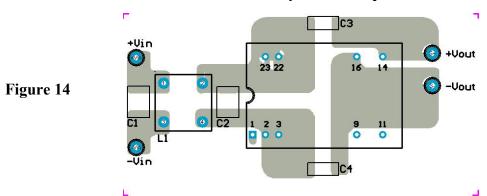
Component	Value	Voltage	Reference
C1	2.2uF	100V	1812 MLCC
C2, C3	1000pF	2KV	1206 MLCC

EMC Considerations (Continued)

Suggested Schematic for EN55022 Conducted Emission Class B limits



Recommended Layout with Input Filter



To meet Conducted Emissions EN55022 CLASS B needed the following components:

LANC12xxW12

Component	Value	Voltage	Reference
C1	3.3µF	50V	1812 MLCC
C3, C4	1000pF	2KV	1206 MLCC
L1	325µH		Common Choke, P/N: PMT-050

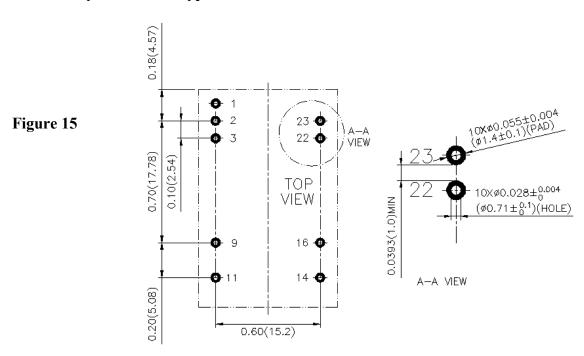
LANC24xxW12

Component	Value	Voltage	Reference	
C1	4.7µF	50V	1812 MLCC	
C3, C4	1000pF	2KV	1206 MLCC	
L1	325µH		Common Choke, P/N: PMT-050	

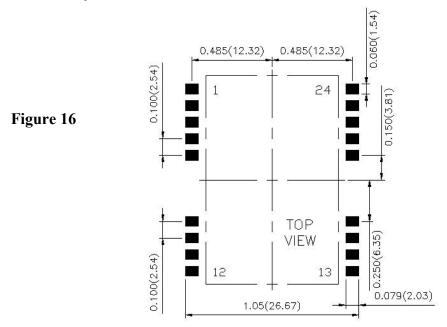
LANC48xxW12

Component	Value	Voltage	Reference	
C1	2.2µF	100V	1812 MLCC	
C3, C4	1000pF	2KV	1206 MLCC	
L1	325µH		Common Choke, P/N: PMT-050	

Recommended Pad Layout for DIP Type



Recommended Pad Layout for SMT Type

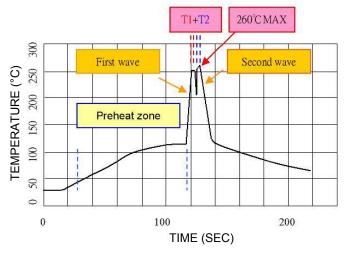


- 1. All dimensions in Inches (mm)
- 2. Pin pitch tolerance ±0.35mm
- 3. Tolerance: x.xx±0.02 (x.x±0.5) x.xxx±0.01 (x.xx±0.25)



Soldering and Reflow Considerations:

Lead Free Wave Solder Profile for DIP Type



Reference Solder: Sn-Ag-Cu; Sn-Cu

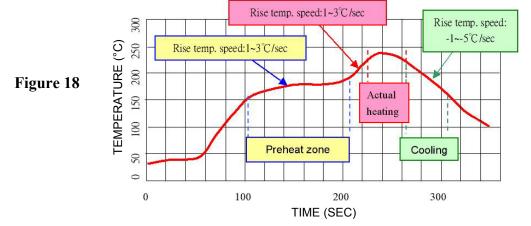
Hand Welding:

Soldering Iron: Power 90W Welding Time: 2~4 sec
Temp: 380~400°C

Figure 17

_	_	
Zone	Reference Parameter	
Preheat	Rise temp. speed: 3°C/sec max.	
Zone	Preheat temp: 100~130°C	
Actual	Peak temp: 250~260°C	
Heating	Peak time (T1+T2 time): 4~6 sec	

Lead free reflow profile for SMT type

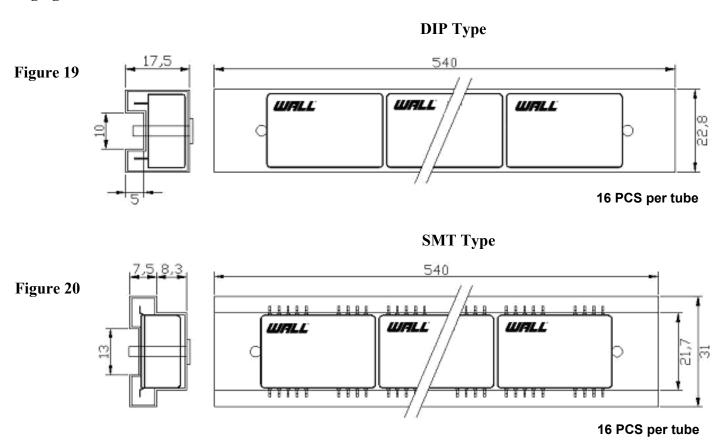


Zone	Reference Parameter
Preheat Zone	Rise temp. speed: 1~3°C/sec Preheat time: 60~120sec Preheat temp.155~185°C
Actual Heating	Rise temp. speed: 1~3°C/sec Melting time: 30~60 sec Melting temp: 217°C Peak temp: 230~240°C Peak time: 10~20 sec
Cooling	Rise temp. speed: -1~ -5°C/sec

Reference Solder: Sn-Ag-Cu; Sn-Cu



Packaging Information:



Safety and Installation Instruction:

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. To maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a normal-blow fuse with maximum rating of 3A. Based on the information provided in this data sheet on Inrush energy and maximum DC input current; the same type of fuse with lower rating can be used. Refer to the fuse manufacturer's data for further information.

MTBF and Reliability

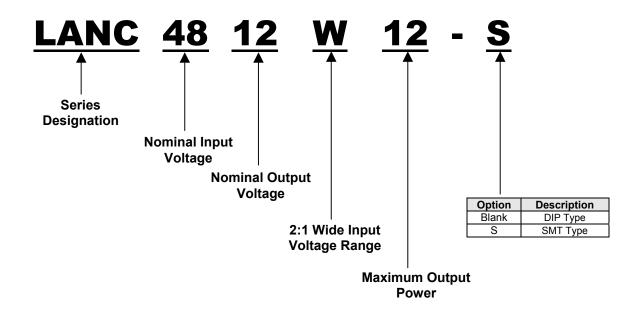
The MTBF of the LANCW12 single output series of DC/DC converters has been calculated using Bellcore TR-NWT-000332 Case I: 50% stress, Operating Temperature at 40°C (Ground fixed and controlled environment). The resulting figure for MTBF is 2.75×10^6 hours.

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 1.078×10^6 hours.



Ordering Information:

Part Number Example:



Company Information:

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Our past projects demonstrate our commitment to you, our customer. Wall Industries, Inc. has a reputation for working closely with its customers to ensure each solution meets or exceeds form, fit and function requirements. We will continue to provide ongoing support for your project above and beyond the design and production phases. Give us a call today to discuss your future projects.

Contact Wall Industries for further information:

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